

Day : Saturday
Date: 4/28/2007

PALM INTRANET

Time: 13:17:07

Application Number Information

Application Number: 10/598124

Examiner Number: 00000 /

Assignments

Filing or 371(c) Date: 08/18/2006 eDan

Group Art Unit: 1742

IFW Madras

Effective Date: 08/18/2006

Class/Subclass: 148/023.000

Application Received: 08/18/2006

Lost Case: NO

Patent Number:

Interference Number:

Issue Date: 00/00/0000

Unmatched Petition: NO

Date of Abandonment: 00/00/0000

L&R Code: Secrecy Code:1

Attorney Docket Number: P30245

Third Level Review: NO

Secrecy Order: NO

Status: 19 /APPLICATION UNDERGOING PREEXAM PROCESSING Status Date: 08/18/2006

Confirmation Number: 1323

Oral Hearing: NO

Title of Invention: SOLDER COMPOSITION AND METHOD OF BUMP FORMATION
THEREWITH

Bar Code	PALM Location	Location Date	Charge to Loc	Charge to Name	Employee Name	Location
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